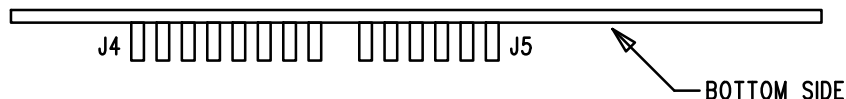
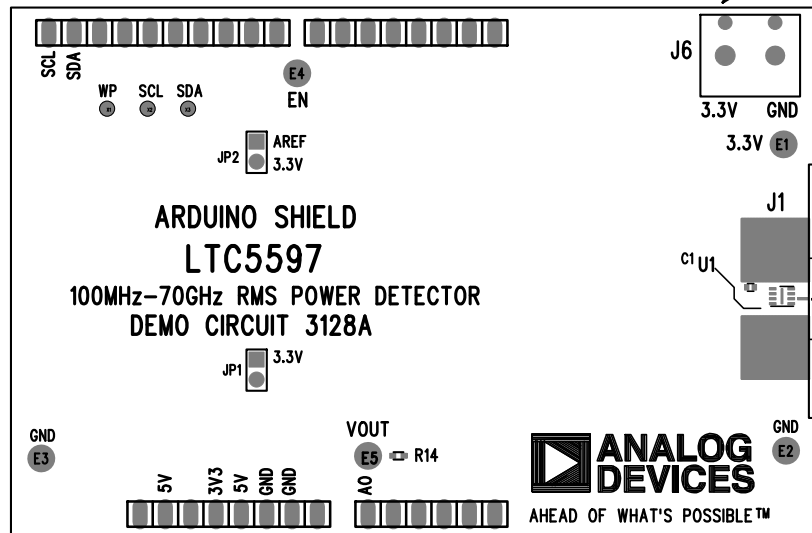
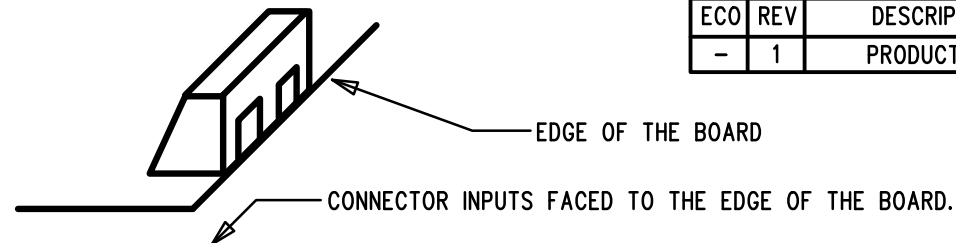


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	1	PRODUCTION	ANDY M.	07-13-20



## NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. NO SHUNT
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. J2, J3, J4, J5 ARE MOUNTED ON BOTTOM SIDE.

UNLESS OTHERWISE SPECIFIED	
DIMENSIONS ARE IN INCHES	
TOLERANCES:	
0.XX" = $\pm 0.01$ "	
0.XXX" = $\pm 0.005$ "	
INTERPRET DIM AND TOL	
PER ASME Y14.5M-1994	
THIRD ANGLE PROJECTION	

APPROVALS	
PCB DES.	KIM T.
APP ENG.	ANDY M.
SCALE = NONE	

 AHEAD OF WHAT'S POSSIBLE™		2555 AUGUSTINE DRIVE SANTA CLARA, CA 95054 <a href="http://www.analog.com">www.analog.com</a>	
		TITLE: ASSEMBLY DRAWING 100MHz-70GHz RMS POWER DETECTOR	
SIZE	IC NO.	LTC5597IDC DEMO CIRCUIT 3128A	REV
N/A			1
FILENAME: DC3128A-1.PCB		SHT 1 OF 2	